



Dual N-Channel 30-V (D-S) MOSFET

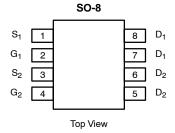
PRODUCT SUMMARY				
V _{DS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)		
30	0.022 @ V _{GS} = 10 V	7.5		
	0.030 @ V _{GS} = 4.5 V	6.5		

FEATURES

- TrenchFET® Power MOSFET
- 100% R_g Tested



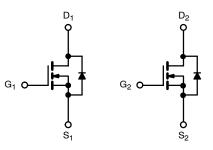
Pb-free Available



Ordering Information: Si4804DY

Si4804DY-T1 (with Tape and Reel)

Si4804DY—E3 (Lead (Pb)-Free) Si4804DY-T1—E3 (Lead (Pb)-Free with Tape and Reel)



N-Channel MOSFET

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ABSOLUTE MAXIMUM RATINGS (TA = 25°C UNLESS OTHERWISE NOTED)							
Parameter		Symbol	10 secs	Steady State	Unit		
Drain-Source Voltage		V _{DS}	30		٧		
Gate-Source Voltage		V_{GS}	± 20				
	T _A = 25°C	- I _D	7.5	5.7			
Continuous Drain Current (T _J = 150°C) ^a	T _A = 70°C		6.0	4.6			
Pulsed Drain Current		I _{DM}	20		Α		
Continuous Source Current (Diode Conduction) ^a		I _S	1.7	0.9			
Single Avalanche Current	1 04 11	I _{AS}	10				
Single Avalanche Energy	L = 0.1 mH	E _{AS}	5		mJ		
Maximum Power Dissipation ^a	T _A = 25°C	-	2.0	1.1	14/		
	T _A = 70°C	P_{D}	1.3	0.7	W		
Operating Junction and Storage Temperature Range	•	T _J , T _{stg}	-55	to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	_	52	62.5			
	Steady State	R _{thJA}	93	110	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	35	40			

Notes a. Surface Mounted on 1" x 1" FR4 Board.

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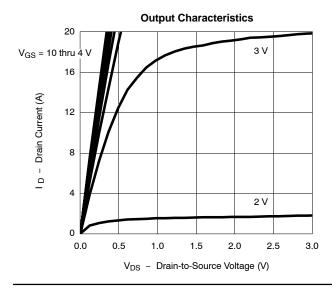
SPECIFICATIONS (T _J = 25°C UNLESS OTHERWISE NOTED)								
Parameter	Symbol	Test Condition	Min	Тур	Max	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	0.8		1.9	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30 V, V _{GS} = 0 V			1			
		$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55^{\circ}\text{C}$			5	μΑ		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	20			Α		
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 7.5 A		0.018 0.022		Ω		
Drain-Gource On-Glate Hesistance		$V_{GS} = 4.5 \text{ V}, I_D = 6.5 \text{ A}$		0.024	0.030	52		
Forward Transconductancea	9fs	V _{DS} = 15 V, I _D = 7.5 A		22		S		
Diode Forward Voltage ^a	V _{SD}	I _S = 1.7 A, V _{GS} = 0 V		0.8	1.2	V		
Dynamic ^b	·							
Total Gate Charge	Qg			13	20			
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 10 V, I_D = 7.5 A		2		nC		
Gate-Drain Charge	Q _{gd}			2.7				
Gate Resistance	R _g		0.5	1.9	4	Ω		
Turn-On Delay Time	t _{d(on)}			8	16			
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		10	20	ns		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 1 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 6 \Omega$		21	40			
Fall Time	t _f			10	20			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 1.7 A, di/dt = 100 A/μs		40	80			

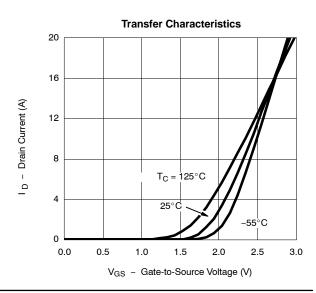
Notes

- Pulse test; pulse width $\leq 300~\mu s$, duty cycle $\leq 2\%$.
- Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)



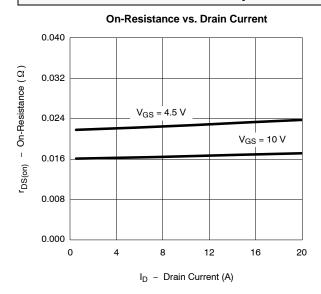


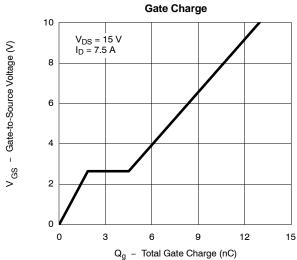


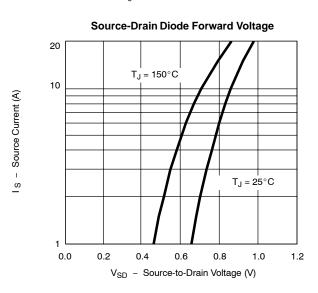


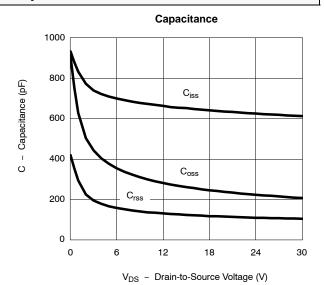
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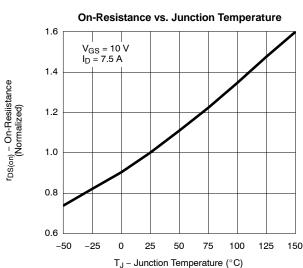
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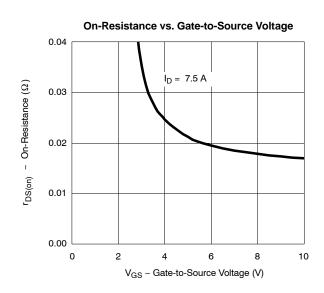








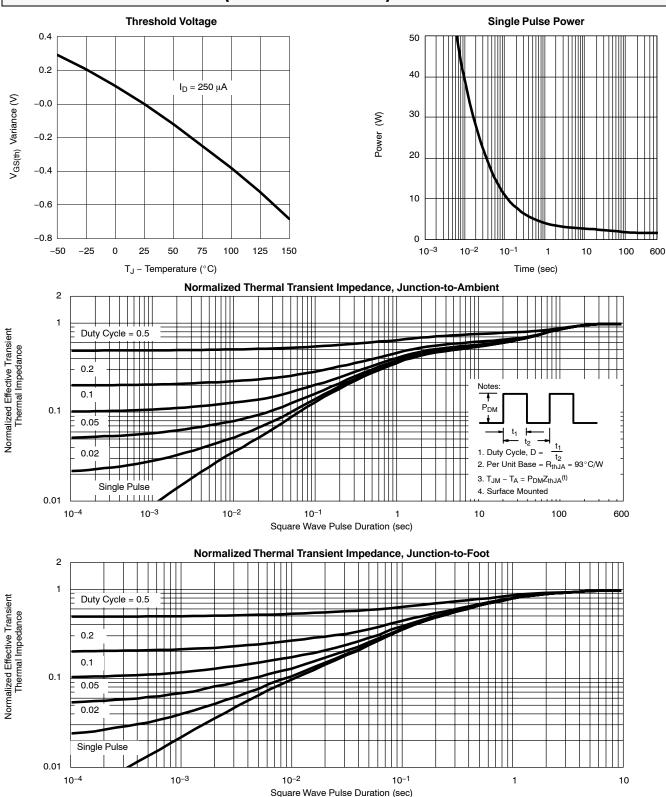




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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?71088.





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